



百盛新纪元半导体

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PULAN TECHNOLOGY CO.,LTD

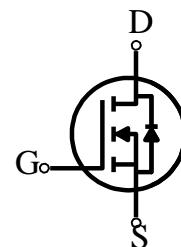
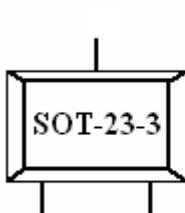
PL2300GD

N-Channel High Density Trench MOSFET

PRODUCT SUMMARY		
VDSS	ID	RDS(on) (m-ohm) Max
20V	5.4	30 @ VGS = 4.5V
	4.3	46 @ VGS = 2.5V

FEATURES

- Super high dense cell trench design for low RDS(on).
- Rugged and reliable.
- Surface Mount package.



ABSOLUTE MAXIMUM RATINGS (TA = 25 °C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	20	V
Gate-Source Voltage	VGS	± 12	V
Drain Current-Continuous ^a @ TA= 25 °C -Pulse ^b	ID	5.4	A
	IDM	21.5	A
Drain-Source Diode Forward Current ^a	IS	1.7	A
Maximum Power Dissipation ^a	PD	1.25	W
		0.75	
Operating Junction and Storage Temperature Range	TJ,TSTG	- 55 to 150	°C

THERMAL CHARACTERISTICS

Thermal Resistance,Junction-to-Ambient ^a	RthJA	100	°C/W
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Note

a. Surface Mounted on FR4 Board , t = 10sec .

b. Pulse width limited by maximum junction temperature.



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ELECTRICAL CHARACTERISTICS (TA= 25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ ^c	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} = 0V , I _D = 250uA	20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20V , V _{GS} = 0V			1	uA
Gate-Body Leakage	I _{GSS}	V _{GS} = 12V , V _{DS} = 0V			100	nA
ON CHARACTERISTICS^b						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250uA	0.6	0.83	1.5	V
Drain-Source On-State Resistance	R _{D(on)}	V _{GS} = 4.5V , I _D = 5.4A		25	30	mohm
		V _{GS} = 2.5V , I _D = 4.3A		34	46	
DRAIN-SOURCE DIODE CHARACTERISTICS^b						
Diode Forward Voltage	V _{SD}	V _{GS} = 0V , I _S = 1.7A			1.2	V
DYNAMIC CHARACTERISTICS^c						
Input Capacitance	C _{ISS}	V _{DS} = 8V , V _{GS} = 0V f = 1.0MHz		512		pF
Output Capacitance	C _{OSS}			130		pF
Reverse Transfer Capacitance	C _{rss}			105		pF
SWITCHING CHARACTERISTICS^c						
Turn-On Delay Time	t _{D(ON)}	V _{DD} = 10V , I _D = 3A V _{GEN} = 4.5V R _L = 3.3 ohm R _{GEN} = 6 ohm		9.8		ns
Rise Time	t _r			3.8		ns
Turn-Off Delay Time	t _{D(OFF)}			21		ns
Fall Time	t _f			5.2		ns
Total Gate Charge	Q _g	V _{DS} = 10V , I _D = 3A V _{GS} = 4.5V		5.7		nC
Gate-Source Charge	Q _{gs}			1.6		nC
Gate-Drain Charge	Q _{gd}			1.3		nC

Note

b. Pulse Test Pulse width 300us , Duty Cycle 2% .

c. Guaranteed by design , not subject to production testing .



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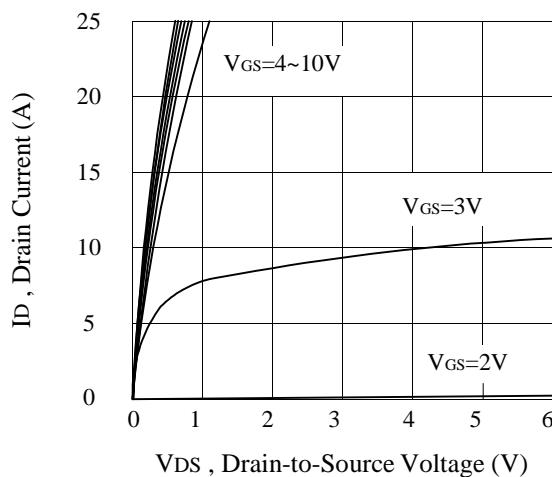


Figure 1. Output Characteristics

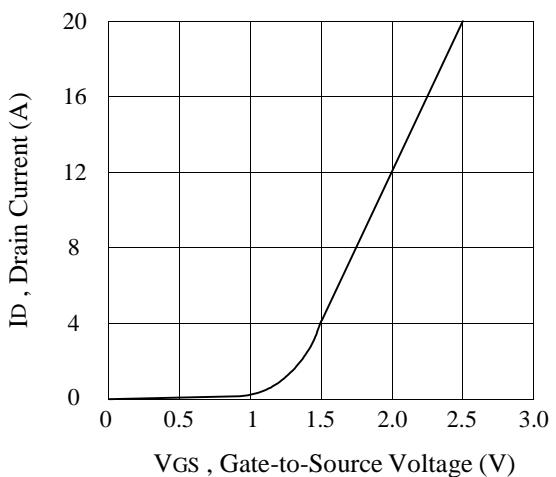


Figure 2. Transfer Characteristics

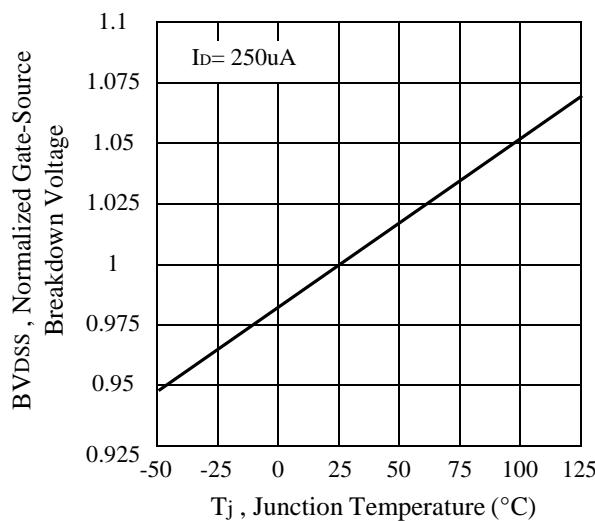


Figure 3. Breakdown Voltage Variation with Temperature

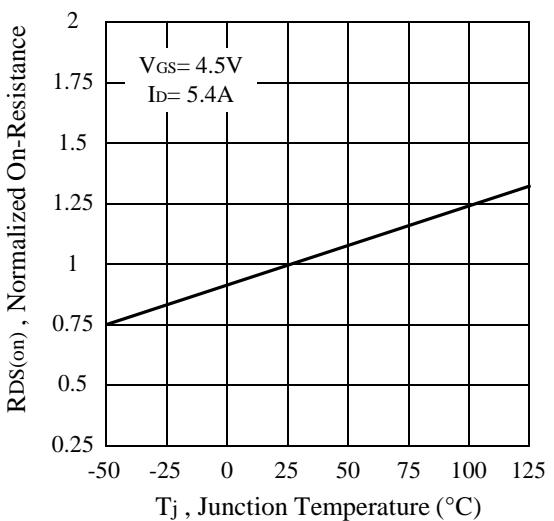


Figure 4. On-Resistance Variation with Temperature

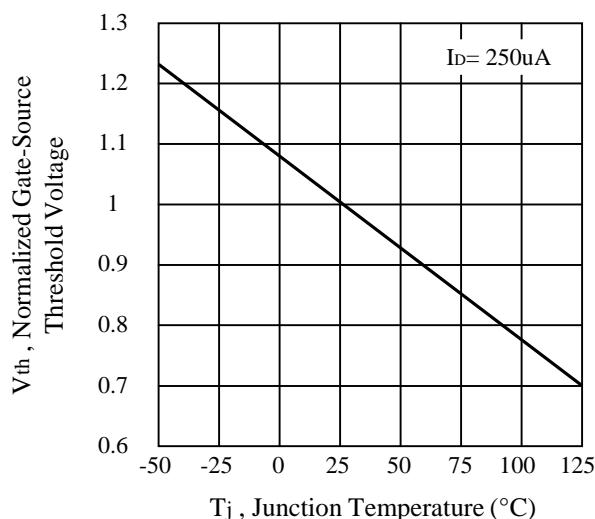


Figure 5. Gate Threshold Variation with Temperature

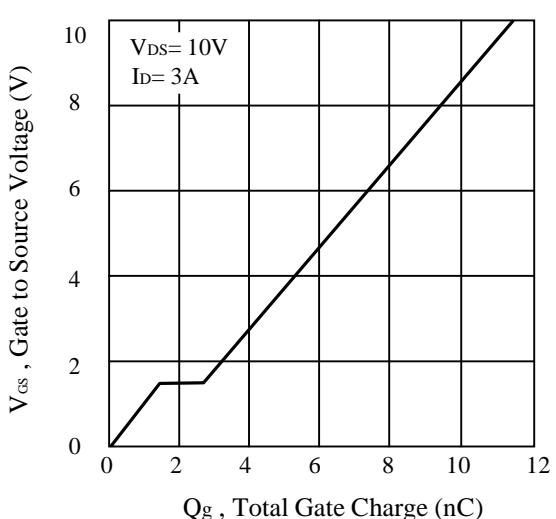


Figure 6. Gate Charge



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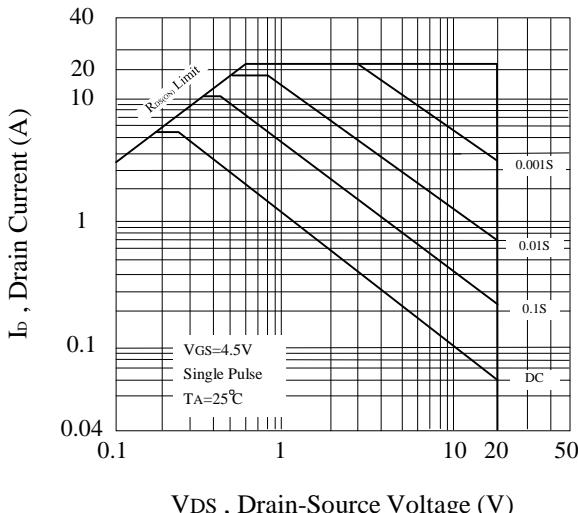


Figure 7. Maximum Safe Operating Area

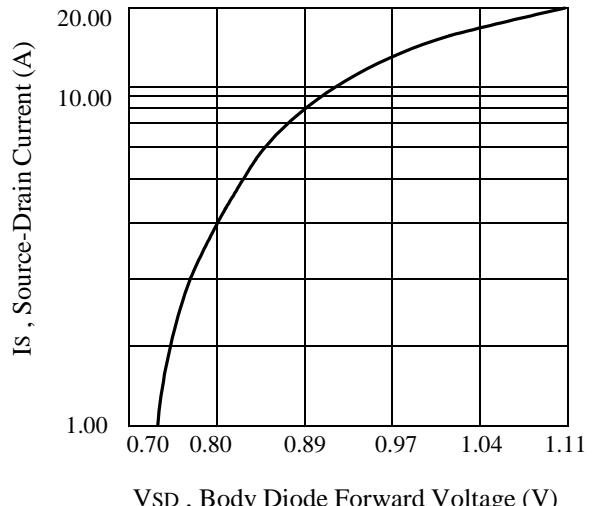


Figure 8. Body Diode Forward Voltage Variation with Source Current

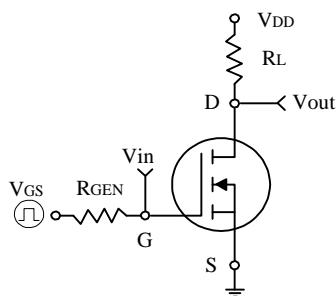


Figure 9. Switching Test Circuit and Switching Waveforms

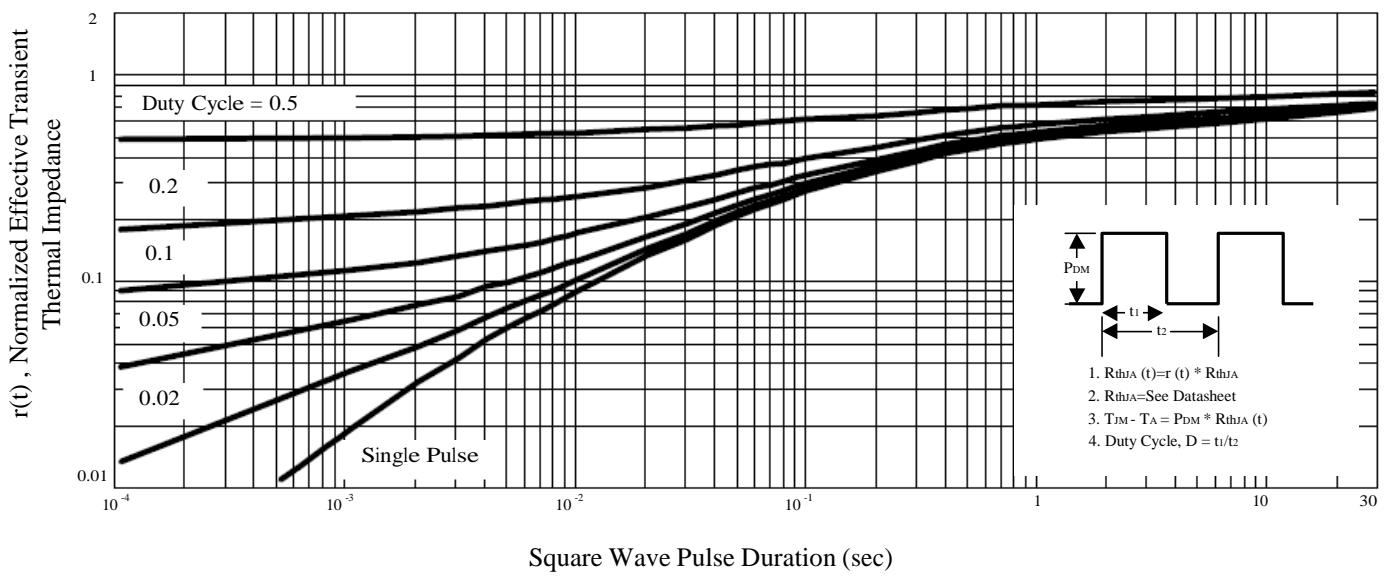


Figure 10. Normalized Thermal Transient Impedance Curve